

Session called to order at 10:02 am ET (all times ET), 14 Oct 2021

Meeting called to order by John D'Ambrosia, who chaired the meeting.

Chair showed IMAT information and asked everyone to sign-in as meeting attendance would be taken from IMAT.

Presentation #1 Agenda and General Information

Presenter: John D'Ambrosia

URL: https://www.ieee802.org/3/B400G/public/21_1014/agenda_b400g_211014.pdf

Chair asked if there were any objections to the agenda, there were none, and the agenda (Slide #2) was considered approved.

Chair noted that the minutes for Sept 2021 Session were not published yet to be considered.

Chair noted that the information regarding the procedures had been sent out, and requested that individuals review the following IEEE SA policies prior to the interim meeting –

- IEEE SA Pre-PAR patent policy
- IEEE SA Copyright Policy
- IEEE SA Participation Policy

Chair asked if anyone needed to review the policies at that time – there were no requests to do so.

Chair asked if anyone needed any of these policies reviewed in-depth. There were no requests.

Chair presented the (See Slide #22) of the IEEE SA Pre-PAR Patent Policy slides.

Chair presented the second slide (See Slide #24) of the IEEE SA Copyright Policy slides. Chair noted – “By participating in this activity, you agree to comply with the IEEE Code of Ethics, all applicable laws, and all IEEE policies and procedures including, but not limited to, the IEEE SA Copyright Policy.”

Chair presented the second slide (See Slide #27) of the IEEE SA Participation Policy slides. Chair noted – “Participants in the IEEE-SA “individual process” shall act independently of others, including employers. By participating in standards activities using the “individual process”, you are deemed to accept these requirements; if you are unable to satisfy these requirements then you shall immediately cease any participation.”

Chair reviewed rules related to voting (See Slide #4) and noted that people should look at rules for gaining 802.3WG Voting Membership

Chair reviewed goals for this meeting. See Slide #5.

Chair reviewed timeline for the Study Group. See Slide #7.

D'Ambrosia asked Issenhuth to assume chairing the call, so he could give the next presentation. Issenhuth started chairing the call approximately 10:15 am.

Presentation #2 Draft - Project Overview - IEEE P802.3df

Presenter John D'Ambrosia

URL https://www.ieee802.org/3/B400G/public/21_1014/B400G_overview_to_dot3_draft0p99.pdf

There was general discussion about the presentation. D'Ambrosia noted he would take the feedback and update the draft presentation for the 28 Oct presentation to the 802.3 WG. D'Ambrosia noted that due to the mostly minor editorial comments on the presentation, he would cancel the 21 Oct SG meeting.

D'Ambrosia resumed chairing the call at approximately 11:10 am.

Chair reviewed future meetings. See Slide #8. The meeting on October 21st was cancelled.

The meeting adjourned at approximately 11:15 am.

Attendees

Name	Employer	Affiliation
BakroNagy, Istvan	EFFECT Photonics	Effect Photonics
Bernier, Eric		Huawei Technologies Canada; Huawei Technologies Co., Ltd
Brown, Matthew	Huawei Technologies Canada	Huawei Technologies Canada
Bruckman, Leon	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Calvin, John	Keysight Technologies	Keysight Technologies
Cassan, Dave	Alphawave	Alphawave
Choudhury, Golam	OFS	OFS
D'Ambrosia, John	Futurewei Technologies	Futurewei Technologies, U.S. Subsidiary of Huawei
Deandrea, John	Finisar Corporation	Finisar Corporation
Ewen, John	Marvell	Marvell
Ferretti, Vincent	Corning Incorporated	Corning Incorporated
Geng, Limin	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC, Marvell
Goodwill, Dominic		Huawei Technologies Canada; Huawei Technologies Co., Ltd
Gustlin, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.
Haasz, Jodi	IEEE - Institute of Electrical and Electronics Engineers	IEEE Standards Association (IEEE-SA)
Han, Ruibo	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)
Haser, Alexandra	Molex Incorporated	Molex Incorporated
He, Xiang	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Healey, Adam	Broadcom Inc.	Broadcom Inc.
Heck, Howard	Intel Corporation	Intel Corporation
Huang, Kechao		Huawei Technologies Co., Ltd
HUANG, QINHUI	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Huber, Thomas	Nokia	Nokia
Hutchins, Jeff	Ranovus	Ranovus
Isono, Hideki	Fujitsu Optical Components Limited	Fujitsu Optical Components Limited
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co., Ltd
Jackson, Kenneth	Sumitomo Electric Device Innovations, USA	Sumitomo Electric Industries, LTD
Jimenez, Andrew	Anixter Inc.	Anixter Inc.
Johnson, John	Broadcom Corporation	Broadcom Corporation
Kabra, Lokesh	Synopsys, Inc.	Synopsys, Inc.
Kim, Kihong/Joshua	Hirose Electric (USA), Inc.	Hirose Electric (USA), Inc.
Kocsis, Sam	Amphenol Corporation	Amphenol Corporation
Koehler, Daniel	MorethanIP	MorethanIP
Le Cheminant, Greg	Keysight Technologies	Keysight Technologies
Levin, Itamar		Intel Corporation
Lewis, David	Lumentum Inc.	Lumentum Inc.
Little, Terrance		Foxconn Electronics Inc.
Liu, Karen	Nubis Communications	Nubis Communications
Lusted, Kent	Intel Corporation	Intel Corporation
Mak, Gary	Inphi Corporation	inphi

Malicoat, David	Malicoat Networking Solutions	Malicoat Networking Solutions; SENKO Advanced Components
Maniloff, Eric	Ciena Corporation	Ciena Corporation
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.
mi, guangcan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Moorwood, Charles	Keysight Technologies	Keysight Technologies
Muller, Shimon	Enfabrica Corp.	Enfabrica Corp.
Nering, Raymond	Cisco Systems, Inc.	Cisco Systems, Inc.
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.
Nicholl, Shawn	Xilinx	Xilinx
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.
Omori, Kumi	NEC Corporation	NEC Corporation
Opsasnick, Eugene	Broadcom Inc.	Broadcom Corporation
PARK, CHUL SOO	Juniper Networks Inc.	Juniper Networks, Inc.
peng, semmy		Huawei Technologies Co., Ltd
Piehler, David	Dell Technologies	Dell
Pimpinella, Rick	Panduit Corp.	Panduit Corp.
Pittala, Fabio	Huawei Technologies Duesseldorf GmbH	Huawei Technologies Duesseldorf GmbH
Rabinovich, Rick	Keysight Technologies	Keysight Technologies
Rahn, Jeffrey	Infinera Corporation	Facebook
Ren, Hao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Rodes, Roberto	II-VI	II-VI
Sakai, Toshiaki	Socionext Inc.	socionext
Savi, Olindo	Hubbell Incorporated	Hubbell Incorporated
Shahramian, Shayan		Alphawave
She, Qingya	Fujitsu Network Communications	Fujitsu Network Communications
Simms, William	NVIDIA Corporation	NVIDIA Corporation
Sommers, Scott	Molex LLC	Molex Incorporated
Son, Yung Sung	Optomind Inc	Optomind Inc
Sorbara, Massimo	GLOBALFOUNDRIES	GLOBALFOUNDRIES
Sprague, Edward	Infinera Corporation	Infinera Corporation
Stassar, Peter	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Sun, Yi		OFS
Tailor, Bharat	Semtech Canada Corporation	Semtech Canada Corporation
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	FUJITSU LIMITED
Terada, Masaru	FURUKAWA ELECTRIC	FURUKAWA ELECTRIC
Theodoras, James	HG Genuine	HG Genuine
Tracy, Nathan	TE Connectivity	TE Connectivity
Trowbridge, Stephen	Nokia	Nokia
Wang, Haojie	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)
Wang, Ruoxu	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Wang, Xinyuan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Weaver, James	Arista Networks	Arista Networks

Wu, Mau-Lin	MediaTek Inc.	MediaTek Inc.
Young, James	CommScope, Inc.	CommScope
Zhuang, Yan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Zivny, Pavel	Tektronix, Inc.	Tektronix, Inc.